## **PCI EXPRESS GEN3 BACKPLANE**

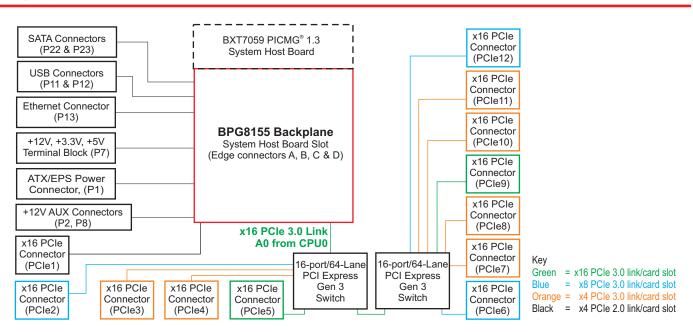


## **FEATURES**

- 14-slot form factor supports one PICMG<sup>®</sup> 1.3 system host board
- Ideal for dual-processor Trenton BXT7059 and other PCIe Gen3 system host boards
- Supports industry standard PCI Express<sup>®</sup> 3.0, 2.0 and 1.1 option cards
- Twelve x16 PCI Express mechanical card slots
- PCIe card slot electrical configuration: two x16, three PCIe x8 and seven PCIe x4
- Offers seamless PCI Express 3.0 operations when using a BXT7059 SHB\*\*
- One 10/100/1000Base-T backplane Ethernet port\*\*
- Four USB 2.0 and two SATA/300 backplane I/O connections\*\*
- ATX/EPS, +12V AUX and terminal block input power connectors
- Five-year factory warranty
- · Made in U. S. A.



#### **BLOCK DIAGRAM:**



#### PCI EXPRESS Gen3 BACKPLANE:

The PCle 3.0 link design of the BPG8155 backplane supports a x16 PCle Gen3 link from Trenton's current BXT7059 system host board as well as the new THD8141 PCle Gen3 SHBs. The backplane's two, 16-port/64-Lane Gen3 switches deliver PCle 3.0 links to option card slots PCle2 through PCle12 while PCle1 is driven with a PCle 3.0/2.0 link from the SHB. Both the switches and the BXT7059 automatically establish communications with either PCl Express 3.0, 2.0 or 1.1 option cards. All option card slots utilize x16 mechanical connectors. Card slots PCle5 and PCle9 are driven with x16 electrical links while card slots PCle2, 6 and PCle12 are driven with x8 electrical links. Card slots PCle3, 4, 7, 8, 10 and 11 are driven with x4 PCle 3.0 links. PCle1 is a slot driven with a x4 interface from the SHB's B0 link. The BPG8155 backplane has a right angle ATX/EPS and two 12V AUX power connectors plus a terminal block to meet expanded system power demands.

#### **APPLICATION EXAMPLES:**

Any 4U rackmount computer design deploying the latest PCIe option cards is a good candidate for the BPG8155 backplane. The ability of the backplane to automatically support either PCI Express 3.0, 2.0 or 1.1 cards builds an element of scalability into any COTS system design. The backplane brings the added value of flexibility to the system by supporting many different types of PCI Express option cards including high-end, x16 PCIe Gen3 video, graphics and GPU cards. The backplane's smaller 14-slot form factor lends itself well to medical diagnostics, military/aerospace, video display wall controllers and communication system designs. The slot support of the backplane enables system designs that can grow and adapt to changing requirements without incurring significant system upgrade expense. The BPG8155's ability to support up to twelve PCIe Gen3 COTS cards maximizes system design flexibility, scalability while enabling robust data communications.

#### **BACKPLANE MODEL: BPG8155**

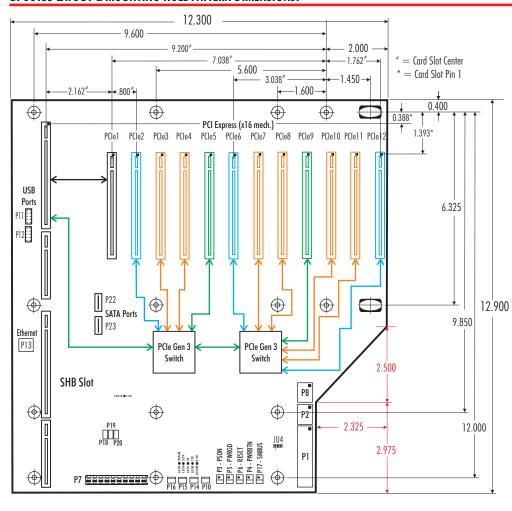
8155-007

MODEL# MODEL NAME

BPG8155-CRA

DESCRIPTION

One ATX/EPS and two 12V AUX right-angle power connectors, one terminal block



# SUGGESTED TRENTON PICMG 1.3 SYSTEM HOST BOARDS:

**DUAL PROCESSOR SHB: BXT7059** 

**SINGLE PROCESSOR SHB: THD8141** 

### **BACKPLANE JUMPER SETTINGS:**

The BPG8155 jumpers are for the most part used during the manufacturing and test of the backplane and have no operational value in most system applications. However, JU4 is the exception to this general rule. JU4 is a +5VAUX jumper that offers a way around the lack of a of the required +5VAUX voltage needed by the SHB in those system configurations using non-ATX/EPS power supplies. Here are the jumper default settings:

Jumper	Function	Pins To Short
P18	SHB I2C Bus	Leave Open, Do No Populate
P19	PCle Switch I2C Bus	Leave Open, Do No Populate
P20	Slot/Clock I2C Bus	Leave Open, Do No Populate
JU4	+5VAUX Source	ATX/EPS supply, Jumper Pins 2-3

# **ENVIRONMENTAL SPECIFICATIONS\***

Operating Temp.:  $0^{\circ}$  C to  $60^{\circ}$  C Storage Temp.:  $-40^{\circ}$  C to  $70^{\circ}$  C

**Humidity:** 5% to 90%, non-condensing

\*Environmental specifications for system host boards/single board computers are usually lower than those of the backplane. Check with your SHB/SBC vendor.

The Trenton BPG8155 is a lead-free, RoHS compliant backplane. This backplane is designed to meet worldwide EMI emissions requirements, CE conformity and immunity standards. Contact Trenton for the specific standard numbers this product. The Trenton BPG8155 backplane is designed for UL60950 and CAN/CSA C22.2 No. 60950-00.

## **ENGINEERING NOTES:**

- 1. The power connectors are shown in the layout drawing represents backplane model number 8155-007.
- 2. Mounting holes: 0.156" diameter
- 3. Nominal PCB thickness: 0.080"
- 4. All dimensions are inches.
- 5. \*\* (from page one) The PCI Express 3.0 links and the optional USB, SATA and Ethernet connectivity is provided by the BXT7059 PICMG 1.3 System Host Board. Not all SHBs support these capabilities.
- 6. PCIe electrical interface key for the option card slots:

Green = Slot driven with a x16 PCle 3.0 link

Blue = Slot driven with a x8 PCle 3.0 link/card slot Orange = Slot driven with a x4 PCle 3.0 link/card slot

Black = Slot driven with a x4 PCIe 2.0 link/card slot

Product Photo Note: The photo of the BPG8155 backplane shown on page one is a provided for illustrative purposes only. Actual connector and mounting locations are illustrated in the backplane layout drawing.

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